

TC 4 (920)

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| 627 | Subclass | ISSUE CLASSIFICATION |
| 628 | Class | |

PATENT NUMBER

U.S. **UTILITY** Patent Application

O.I.P.E.
A. G.
SCANNED **Q.A.** **A. G.**

PATENT DATE

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|------------------------------|-----------------|--------------|-----------------|------------------|----------------------|
| APPLICATION NO. 09/849460 | CONT/PRIOR F | CLASS 438 | SUBCLASS 627 | ART UNIT 2812 | EXAMINER Yevsikov |
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Process for forming a conducting structure layer that can reduce metal etching residue

PTO-2040
12/99

ISSUING CLASSIFICATION

Continued on Issue Slip Inside File Jacket

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